Panasonic ideas for life





2.2 mm Ultra-slim body with the inherited high reliability

AHUS

Panasonic ideas for life





Compliance with RoHS Directive

For board-to-FPC

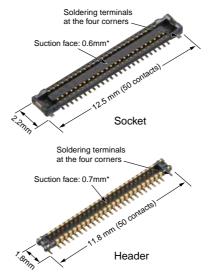
Narrow pitch connectors (0.4mm pitch)

A4US Series

FEATURES

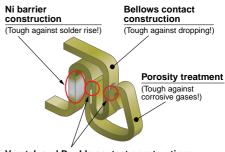
1. Ultra-slim (Mated width: 2.2 mm and Mated height: 0.8 mm, 1.0 mm and 1.5 mm)

The footprint when mated is down approx. 12% from our existing A4S model (50 contacts), contributing to the functionality enhancement and size reduction of target equipment.



- * Suction face size for the 1.0 mm/1.5 mm mated height type: Socket 0.64 mm, Header 0.76 mm
- 2. Improving the degree of design freedom (Mated height of 0.8 mm, 1.0 mm, or 1.5 mm with the same foot pattern)

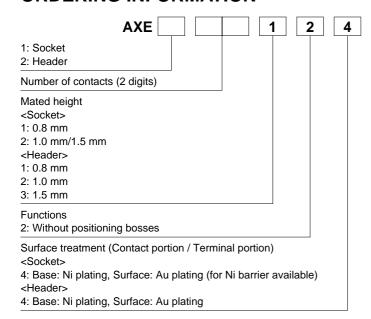
3. "TDUGH CONTRET FOURNCED" structure adopted to ensure high resistance to various environments in spite of the ultra-slim space-saving body.



V notch and Double contact constructions
(Tough against foreign particles and flux!)

- 4. The simple lock structure for high mating/unmating operation feel.
 5. The contact at the four corners enhance the mounting strength.
 6. The gull-wing-shaped terminals facilitate imaging inspections.
- **APPLICATIONS**
- Particularly suitable for board-to-FPC connections in ultra-compact mobile equipment that requires size and thickness reduction and functionality enhancement

ORDERING INFORMATION



PRODUCT TYPES

Mated height	Number of contacts	Part number		Packing		
wateu neignt	Number of contacts	Socket	Header	Inner carton (1-reel)	Outer carton	
	10	AXE110124	AXE210124			
	14	AXE114124	AXE214124			
	20	AXE120124	AXE220124			
	24	AXE124124	AXE224124			
	30	AXE130124	AXE230124			
0.8mm	36	AXE136124	AXE236124			
	40	AXE140124	AXE240124	5,000 pieces	10,000 pieces	
	50	AXE150124	AXE250124			
	60	AXE160124	AXE260124			
	70	AXE170124	AXE270124			
	80	AXE180124	AXE280124			
	20	AXE120224	AXE220224			
1.0mm	34	AXE134224	AXE234224			
1.0111111	60	AXE160224	AXE260224			
	80	AXE180224	AXE280224			
	20	AXE120224	AXE220324			
1.5mm	60	AXE160224	AXE260324			
	80	AXE180224	AXE280324			

Notes: 1. Order unit:

For mass production: in 1-inner carton (1-reel) units

- Samples for mounting check: in 50-connector units. Please contact our sales office.

 2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our
- ${\it 3. Please contact us for connectors having a number of contacts other than those listed above.}\\$

SPECIFICATIONS

1. Characteristics

	Item	Specifications	Conditions
	Rated current	0.30A/contact (Max. 5 A at total contacts)	
	Rated voltage	60V AC/DC	
Electrical characteristics	Breakdown voltage	150V AC for 1 min.	No short-circuiting or damage at a detection current of 1 mA when the specified voltage is applied for one minute.
onaracionstics	Insulation resistance	Min. 1,000M Ω (initial)	Using 250V DC megger (applied for 1 min.)
	Contact resistance	Max. 90mΩ	Based on the contact resistance measurement method specified by JIS C 5402.
	Composite insertion force	Max. 0.981N/contacts × contacts (initial)	
Mechanical	Composite removal force	Min. 0.165N/contacts × contacts	
characteristics	Contact holding force (Socket contact)	Min. 0.20N/contacts	Measuring the maximum force. As the contact is axially pull out.
	Ambient temperature	-55°C to +85°C	No freezing at low temperatures. No dew condensation.
	Soldering heat resistance	Peak temperature: 260°C or less (on the surface of the PC board around the connector terminals)	Infrared reflow soldering
	-	300°C within 5 sec. 350°C within 3 sec.	Soldering iron
	Storage temperature	-55°C to +85°C (product only) -40°C to +50°C (emboss packing)	No freezing at low temperatures. No dew condensation.
Environmental characteristics	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100MΩ, contact resistance max. $90mΩ$	Sequence 1. –55.3°C, 30 minutes 2. ~, Max. 5 minutes 3. 85*3°C, 30 minutes 4. ~, Max. 5 minutes
	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100M Ω , contact resistance max. 90m Ω	Bath temperature 40±2°C, humidity 90 to 95% R.H.
	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100M Ω , contact resistance max. 90m Ω	Bath temperature 35±2°C, saltwater concentration 5±1%
	H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. $90m\Omega$	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.
Lifetime characteristics	Insertion and removal life	30 times	Repeated insertion and removal speed of max. 200 times/ hours
		60 contacts Socket (h = 0.8mm: 0.03g, h = 1.0/1.5m Header (h = 0.8mm: 0.01g, h = 1.0mm:	

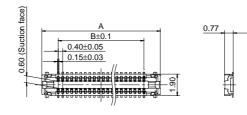
2. Material and surface treatment

Part name	Material	Surface treatment
Molded	LCP resin	
portion	(UL94V-0)	
Contact and Post	Copper alloy	Contact portion: Base: Ni plating, Surface: Au plating Terminal portion: Base: Ni plating, Surface: Au plating (except the terminal tips) The socket terminals close to the portion to be soldered have nickel barriers (exposed nickel portions). Soldering terminals: Sockets: Base: Ni plating, Surface: Pd+Au flash plating (except the terminal tips) Headers: Base: Ni plating, Surface: Au plating (except the terminal tips)

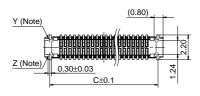
DIMENSIONS (Unit: mm)

Socket (Mated height: 0.8 mm)









General tolerance: ±0.2

Terminal coplanarity

(Contact and soldering terminals)

0.08

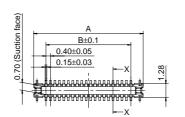
Dimension table (mm)

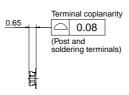
Difficusion table (min)				
Number of contacts/ dimension	А	В	С	
10	4.5	1.6	3.6	
14	5.3	2.4	4.4	
20	6.5	3.6	5.6	
24	7.3	4.4	6.4	
30	8.5	5.6	7.6	
36	9.7	6.8	8.8	
40	10.5	7.6	9.6	
50	12.5	9.6	11.6	
60	14.5	11.6	13.6	
70	16.5	13.6	15.6	
80	18.5	15.6	17.6	

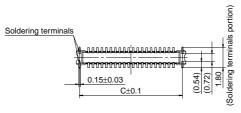
Note: Since soldering terminals are built into the body, the Y and Z parts are connected electrically.

Header (Mated height: 0.8 mm)







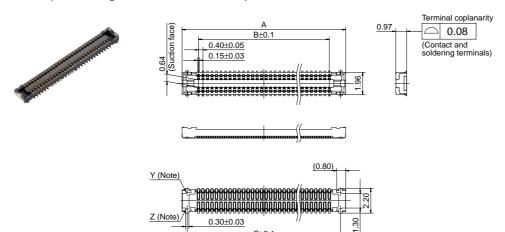


General tolerance: ±0.2

Dimension table (mm)

Number of contacts/ dimension	А	В	С
10	3.8	1.6	3.2
14	4.6	2.4	4.0
20	5.8	3.6	5.2
24	6.6	4.4	6.0
30	7.8	5.6	7.2
36	9.0	6.8	8.4
40	9.8	7.6	9.2
50	11.8	9.6	11.2
60	13.8	11.6	13.2
70	15.8	13.6	15.2
80	17.8	15.6	17.2

Socket (Mated height: 1.0 mm and 1.5 mm)



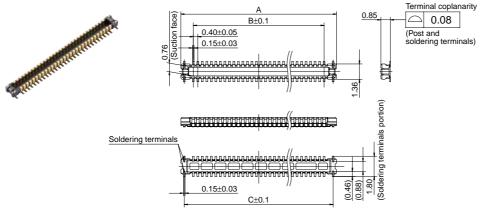
General tolerance: ±0.2

Dimension table (mm)

Number of contacts/ dimension	Α	В	С
20	6.5	3.6	5.6
34	9.3	6.4	8.4
60	14.5	11.6	13.6
80	18.5	15.6	17.6

Note: Since soldering terminals are built into the body, the Y and Z parts are connected electrically.

Header (Mated height: 1.0 mm)

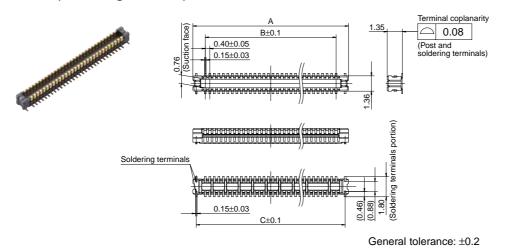


General tolerance: ±0.2

Dimension table (mm)

Number of contacts/ dimension	Α	В	С
20	5.8	3.6	5.2
34	8.6	6.4	8.0
60	13.8	11.6	13.2
80	17.8	15.6	17.2

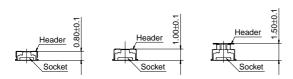
Header (Mated height: 1.5 mm)



Dimension table (mm)

Number of contacts/ dimension	Α	В	С
20	5.8	3.6	5.2
60	13.8	11.6	13.2
80	17.8	15.6	17.2
	•		

Socket and Header are mated



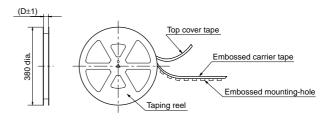
EMBOSSED TAPE DIMENSIONS (Unit: mm)

· Specifications for taping

(In accordance with JIS C 0806-3:1999. However, not applied to the mounting-hole pitch of some connectors.)

Specifications for the plastic reel

(In accordance with EIAJ ET-7200B.)



• Dimension table (Unit: mm)

	Type/Mated height	Number of contacts	Type of taping	А	В	С	D	Quantity per reel
Common for sockets and headers:	Max. 24	Tape I	16.0	_	7.5	17.4	5,000	
	30 to 70	Tape I	24.0	_	11.5	25.4	5,000	
	0.8mm, 1.0mm and 1.5mm	80	Tape II	32.0	28.4	14.2	33.4	5,000

• Connector orientation with respect to embossed tape feeding direction

Direction of tape progress		Common for A4US
	Socket	Header
•		
	Note: Ther	e is no indication on this product regarding top-bottom or left-right orientation.

NOTES

1. Regarding the design of PC board patterns

Conduct the recommended foot pattern design, in order to preserve the mechanical strength of terminal solder areas.

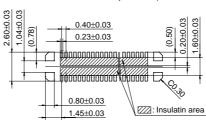
2. Recommended PC board and metal mask patterns

Appropriate control of solder amount is required to minimize solder bridges and other defects for connectors with 0.35 mm, 0.4 mm or 0.5 mm pitch terminals, which require high-density mounting. Refer to the right-hand drawing for recommended patterns.

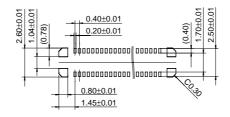
3. See the common "NOTES FOR USE" on the next page for other points to be noted.

Socket (Mated height: 0.8 mm, 1.0 mm and 1.5 mm)

Recommended PC board pattern (TOP VIEW)

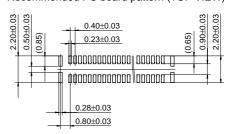


Recommended metal mask opening pattern Metal mask thickness: When 120µm (Terminal opening ratio: 70%) (Metal-part opening ratio: 100%)

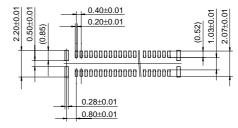


Header (Mated height: 0.8 mm, 1.0 mm and 1.5 mm)

Recommended PC board pattern (TOP VIEW)



Recommended metal mask opening pattern Metal mask thickness: When 120µm (Terminal opening ratio: 70%) (Metal-part opening ratio: 100%)



NOTES FOR USE

■ Connector mounting

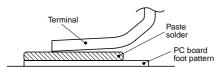
When the working environment is dry, be careful for static buildup.

The buildup of static electricity occasionally causes the products to cling to the taping material. To prevent static buildup, it is recommended that you maintain the relative humidity of your working environment at 40 to 60%, while eliminating static using an ionizer or other means

■ Soldering

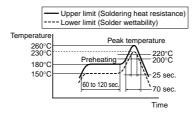
- 1) Manual soldering.
- Due to the low profile, if an excessive amount of solder is applied to this product during manual soldering, the solder may creep up to near the contact points, or interference by solder may cause imperfect contact.
- Make sure that the soldering iron tip is heated within the temperature and time limits indicated in the specifications.
- Flux from the solder wire may adhere to the contact surfaces during soldering operations. After soldering, carefully check the contact surfaces and clean off any flux before use.
- Be aware that a load applied to the connector terminals while soldering may displace the contact.
- Thoroughly clean the iron tip. 2) Reflow soldering
- · Screen-printing is recommended for printing paste solder.
- To determine the relationship between the screen opening area and the PCboard foot pattern area, refer to the diagrams in the recommended patterns for PC boards and metal masks. Make sure to use the terminal tip as a reference position when setting.

Avoid an excessive amount of solder from being applied, otherwise, interference by the solder will cause an imperfect contact.



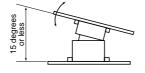
- · Consult us when using a screen-printing thickness other than that recommended.
- Depending on the size of the connector being used, self alignment may not be possible. Accordingly, carefully position the terminal with the PC board pattern.

 The recommended reflow temperature profile is given in the figure below Recommended reflow temperature profile



- The temperature is measured on the surface of the PC board near the connector terminal.
- Some solder and flux types may cause serious solder creeping. Take the solder and flux characteristics into consideration when setting the reflow soldering conditions.
- 3) Reworking on a soldered portion
- Finish reworking in one operation.
- For reworking of the solder bridge, use a soldering iron with a flat tip. Do not add flux, otherwise, the flux may creep to the contact parts.
- Use a soldering iron whose tip temperature is within the temperature range specified in the specifications.
- Do not drop the product or handle it carelessly. Otherwise, the terminals may become deformed due to excessive force or the solderability during reflow soldering may degrade.
- Do not insert or remove the connector when it is not soldered. Also, forcibly applied external pressure on the terminals can weaken the adherence of the terminals to the molded part or cause the terminals to lose their evenness.
- Excessive prying-force applied to one end may cause product breakage and separation of the solder joints at the terminal.

In particular, when removing the connector, be sure not to tilt the connector exceeding 15 degrees widthwise. Excessive force applied for insertion in a pivot action as shown may also cause product breakage. Align the header and socket positions before connecting them.



■ When cutting or bending the PC board after mounting the connector, be careful that the soldered sections are subjected to excessive forces.

Do not the soldered areas to be subjected to forces

■ Notes when using a FPC.

When the connector is soldered to an FPC board, during its insertion and removal procedures, forces may be applied to the terminals and cause the soldering to come off. It is recommended to use a reinforcement board on the backside of the FPC board to which the connector is being connected. Make sure that the reinforcing plate is larger than the outline of the recommended PC board pattern (Outline + approx. 1 mm). The reinforcing plate is made of glass epoxy or polyimide that is 0.2 to 0.3 mm thick. This connector employs a simple locking structure. However, the connector may come off depending on the size and weight of the FPC, layout and reaction force of FPC, or by drop impact. Make sure to fully check the equipment's condition. To prevent any problem with loose connectors, adopt measures to prevent the connector from coming off inside the equipment.

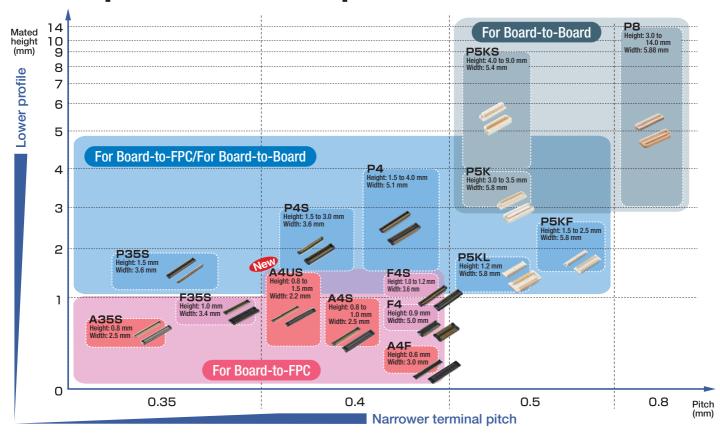
Other Notes

for switching.

When coating the PC board after soldering the connector to prevent the deterioration of insulation, perform the coating in such a way so that the coating does not get on the connector. The connectors are not meant to be used

When designing the target equipment, please verify with the latest product specifications.

Narrow-pitch Connector Lineup Narrow-pitch Connector



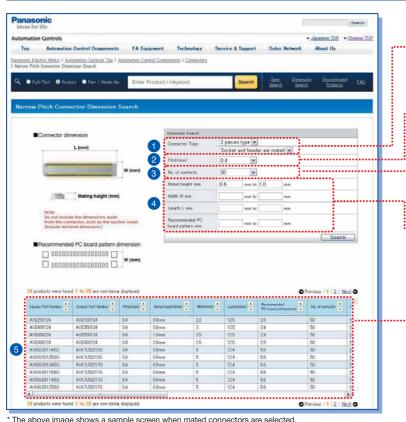
Introduction of Our Website for Dimension Search

panasonic-denko.co.jp/acc/e-size/ Connector Dimensions Search Search

3D and 2D CAD data







Connector Type

You can select

"Socket and header are mated", "Socket", or "Head".

Pitch (mm)

You can specify the terminal pitch.

No. of contacts

You can specify the number of contacts.

4 Dimension criteria (required)

You can search by specifying criteria for one or more of the dimensions, which are the "Mated height", "Width", and "Length".

Search results

All connectors that meet the dimension criteria you entered will be listed.

- * The result list can be sorted by a dimension, part number, or other criteria.
- You can add search criteria to narrow down the results.

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Mouser Electronics

Authorized Distributor

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AXE220324 AXE222224 AXE222324 AXE224224 AXE226224 AXE26324 AXE228224 AXE228324 AXE230224

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AXE238324 AXE240224 AXE240324 AXE234224 AXE242324 AXE234224 AXE236324 AXE24324 AXE246324

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